







TPS92200 JAJSJ57B - MAY 2020 - REVISED JANUARY 2022

TPS92200 入力電圧 4V~30V、出力電流 1.5A、 同期整流降圧 LED ドライバ、フレキシブル調光オプション搭載

1 特長

- 4.5V~30Vの広い入力電圧範囲
- 150mΩ および 90mΩ の MOSFET を内蔵し、 1.5A の連続出力電流に対応
- 非常に低いシャットダウン電流:1µA
- 負荷からの非常に低い出力放電電流:1µA
- 1MHz のスイッチング周波数
- 最大デューティ・サイクル:99%
- 内部補償付きピーク電流モード
- フレキシブルな調光オプション:
 - TPS92200D1:デジタル入力による PWM 調光お よびアナログ入力によるアナログ調光
 - TPS92200D2:デジタル入力によるアナログ調光
- 高精度できわめて低い FB 電圧:99mV±3mV
- 包括的な保護機能を搭載:
 - LED 負荷開放保護
 - LED+の GND への短絡保護、自動リトライ付き
 - LED + と LED- の短絡保護、自動リトライ付き
 - センス抵抗の開放保護とGNDへの短絡保護、自 動リトライ付き
 - サーマル・シャットダウン保護、自動リトライ付き
- SOT-23 (6) パッケージ
- VQFN-HR (6) パッケージ

2 アプリケーション

- ビデオ監視用IR/白色LEDドライバ
- 顔認識 IR LEDドライバ
- ステージ照明 LED ドライバ
- 一般的な工業用および商業用照明
- 医療用 UV LED ドライバ
- 単三またはリチウムイオン・バッテリ・チャージャ

3 概要

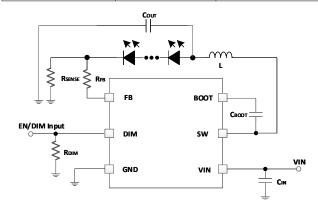
TPS92200 は 1.5A の同期整流降圧 LED ドライバで、最 大入力電圧は 30V です。TPS92200 は、ハイサイドとロ ーサイドの NMOS スイッチを統合することで、超小型ソリ ューション・サイズで高電力密度と高効率を実現します。 TPS92200 デバイスは、ピーク電流モード制御と完全な 内部補償を採用しており、広範な動作条件にわたって高 い過渡応答性能を実現します。

TPS92200 デバイスは、フレキシブルな調光方式をサポ ートしています。TPS92200D1 は、PWM とアナログの両 方の調光モードを実装しています。 PWM 調光モードで は、PWM のデューティ・サイクルに応じて LED が周期的 にオンまたはオフになります。このデバイスのアナログ調光 モードは、アナログ入力の電圧レベルに比例して内部基 準電圧を 5%~100% の範囲で変化させることにより行わ れます。TPS92200D2 には、より深いアナログ調光が実 装されており、このモードでは PWM 信号入力のデューテ ィ・サイクルに比例して内部基準電圧を 1%~100% の範 囲で変化させて調光します。

安全と保護のために、TPS92200 デバイスには、LED 開 放、LED+とGND の短絡、LED 短絡、センス抵抗開放と 短絡、デバイス過熱保護など、完全な保護機能が実装さ れています。

製品情報

部品番号	パッケージ	本体サイズ (公称)
TPS92200D1DDCR	SOT-23-THIN (6)	1.60mm × 2.90mm
TPS92200D2DDCR	SOT-23-THIN (6)	1.60mm × 2.90mm
TPS92200D1RXLR	VQFN-HR (6)	1.50mm × 2.00mm
TPS92200D2RXLR	VQFN-HR (6)	1.50mm × 2.00mm



概略回路図



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3			
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4 Revision History			
資料番号末尾の英字は改訂を表しています。その	の改訂履歴は	は英語版に準じています。	

Changes from Revision A (September 2021) to Revision B (January 2022)	Page
• VQFN-HR パッケージのプレビューの注を削除	1
Updated ESD Ratings table with correct description for CDM testing	
Changes from Revision * (May 2020) to Revision A (September 2021)	Page
・ 文書全体にわたって表、図、相互参照の採番方法を更新	1
• VQFN-HR パッケージ情報を追加	
• VQFN-HR パッケージ情報を追加	1
Add VQFN-HR package information	
Added VQFN-HR package information	

5 Pin Configuration and Functions

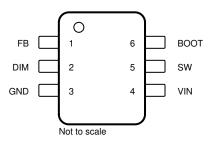


図 5-1. DDC Package 6-Pin SOT-23-THIN Top View

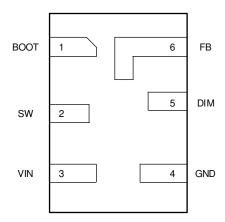


図 5-2. RXL Package 6-Pin VQFN-HR Top View

表 5-1. Pin Functions

	PIN		TYPE (1)	DESCRIPTION
NAME	DDC NO.	RXL NO.		DESCRIPTION
воот	6	1	0	A bootstrap capacitor is required between BOOT and SW.
FB	1	6	I LED current detection feedback	
GND	3	4	G	Power ground
DIM	2	5	I	Dimming input. In PWM dimming mode, LED current is turned ON and OFF according to PWM duty cycle periodically (TPS92200D1). In analog dimming mode, the internal reference is proportional to the analog voltage on DIM pin (TPS92200D1) or the PWM duty input (TPS92200D2).
SW	5	2	O Switching node to external inductor	
VIN	4	3	Р	Input supply voltage

(1) I = Input, O = Output, P = Supply, G = Ground



6 Specifications

6.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
	IN	-0.3	32	V
Input voltage range, V _I	DIM	-0.3	7	V
	FB	-0.3	7	V
	BOOT-SW	-0.3	7	V
Output voltage range, V _O	SW	-0.3	32	V
	SW (20 ns transient)		32	V
Operating junction temperature, T _J		-40	150	°C
Storage temperature range, T _{stg}		-6:	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
V		Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
V _(ESD) Electrostatic discharge	Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	±500	•	

- (1) JEDEC document JEP155 states that 500-V HBM allows safemanufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safemanufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	IN	4	30	V
Input voltage range	DIM	-0.1	6	V
	FB	-0.1	6	V
Output voltage range	BOOT-SW	-0.1	6	V
Output voitage range	SW	-0.1	30	V
Operating Junction temperature, T _J		-40	125	°C

6.4 Thermal Information

		TPS92200	TPS92200	
	THERMAL METRIC ⁽¹⁾	DDC (SOT23-6)	RXL (VQFN-HR-6)	UNIT
		6 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	123.4	136.1	°C/W
R _{0JC(top)}	Junction-to-case (top) thermal resistance	60.5	95.3	°C/W
R _{0JB}	Junction-to-board thermal resistance	41.4	49.3	°C/W
ΨЈТ	Junction-to-top characterization parameter	12.3	4.6	°C/W
ΨЈВ	Junction-to-board characterization parameter	40.9	48.1	°C/W

(1) For more information about traditional and new thermalmetrics, see the Semiconductor and IC Package Thermal Metricsapplication report, SPRA953.

Product Folder Links: TPS92200

6.5 Electrical Characteristics

The electrical ratings specified in this section apply to all specifications in this document, unless otherwise noted. These specifications are interpreted as conditions that do not degrade the device parametric or functional specifications for the life of the product containing it. $T_J = -40$ °C to +125°C, $V_{IN} = 4$ V to 30 V, (unless otherwise noted).

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT SUPPLY			·		'	
V _{IN}	Input voltage range		4		30	V
)/d-= := k-==	Rising V _{IN}	3.5	3.7	3.9	V
V _{IN_UVLO}	V _{IN} undervoltage lockout	Falling V _{IN}	3.3	3.5	3.7	V
	Hysteresis			0.2		V
I _{SD}	Shut down current from V _{IN}	V _{IN} = 12 V, V _{DIM} = 0 V		1	3	μΑ
I _{DISC}	Discharge current from SW and BOOT	V _{IN} floating, V _{DIM} = 0 V		1	3	uA
I _{OP}	Normal operating current	V _{DIM} = 3.3 V		0.5	1	mA
DIMMING		-	<u>'</u>		'	
V _{DIM_L}	Low-level input voltage				0.3	V
V _{DIM_H}	High-level input voltage		0.65			V
V _{ANA}	Analog dimming range (TPS92200D1 only)		0.65		1.2	V
t _{DIM_ON1}	DIM minimum on time to enable device (TPS92200D2 only)	V _{DIM} = 3.3 V		190	300	nS
t _{DIM_ON2}	DIM minimum on time when PWM dimming (TPS92200D2 only)	V _{DIM} = 3.3 V			150	nS
t _{DIM_OFF}	DIM minimum off time to disable device	V _{DIM} = 0 V		36		mS
FEEDBACK AND	D ERROR AMPLIFIER		"			
V _{FB_REF}	FB pin reference voltage	V _{DIM} = 3.3 V	96	99	102	mV
V _{FB_OVP}	FB pin over voltage protection threshold	V _{DIM} = 3.3 V		140		mV
V _{FB_DMAX}	FB reference voltage when maximum dimming input (TPS92200D1 only)	V _{DIM} = 1.2 V		99		mV
V	FB reference voltage when minimum dimming input (TPS92200D1 only)	V _{DIM} = 0.65 V		5		mV
V _{FB_DMIN}	FB reference voltage when minimum dimming duty cycle (TPS92200D2 only)	DIM pin duty cycle <= 3%		1		mV
POWER STAGE		-	<u>'</u>		'	
R _{HS}	High-side FET on resistance	V _{IN} ≥ 5 V		150		mΩ
R _{LS}	Low-side FET on resistance	V _{IN} ≥ 5 V		90		mΩ
CURRENT LIMIT	T.	-1	1			
I _{LIM_HS}	High-side current limit		2.9	3.3	4	Α
I _{LIM_LS_SOUR}	Low-side sourcing current limit		2.4	3	3.6	Α
I _{LIM_LS_SINK}	Low-side sinking current limit		1.4	1.8	2.4	Α
THERMAL PROT	TECTION	•	'		1	
-	Thermal shutdown temperature			165		°C
T _{TSD}	Hysteresis			15		°C
	1	1				



6.6 Timing Requirements

			MIN	TYP	MAX	UNIT
Auto-Retry Timing	uto-Retry Timing					
t _{RETRY_ON}	Auto-retry on-time			512		Cycles
t _{RETRY_OFF}	Auto-retry off-time			60		ms
SOFT START						
t _{SS}	Internal soft-start time			0.5		ms

Switching Characteristics

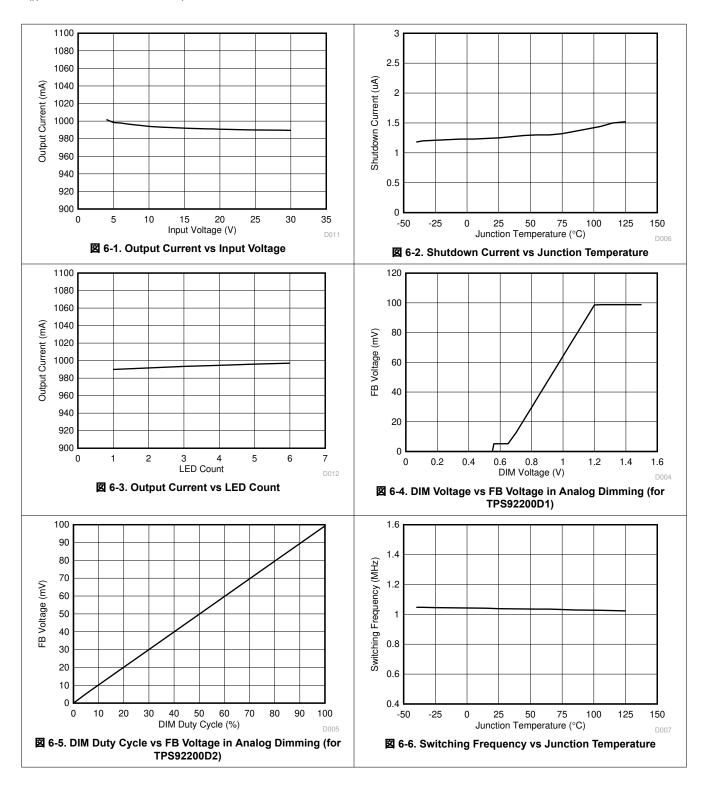
 $T_J = -40$ °C to +125°C, $V_{IN} = 4V$ to 30V, (unless otherwise noted).

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{sw}	Switching frequency		0.8	1	1.2	MHz
D _{MAX}	Maximum duty cycle			99%		
t _{MIN_ON}	Minimum on time			75	100	ns
t _{MIN_OFF}	Minimum off time			65	90	ns
t _{MAX_ON}	Maximum on time			6.6		us

Product Folder Links: TPS92200

6.7 Typical Characteristics

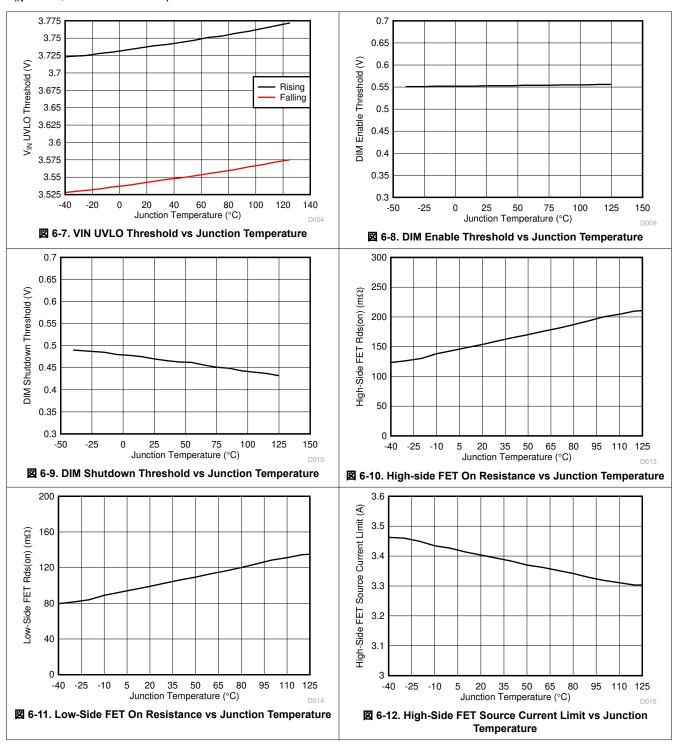
V_{IN} = 12 V, unless otherwise specified.





6.7 Typical Characteristics (continued)

 V_{IN} = 12 V, unless otherwise specified.

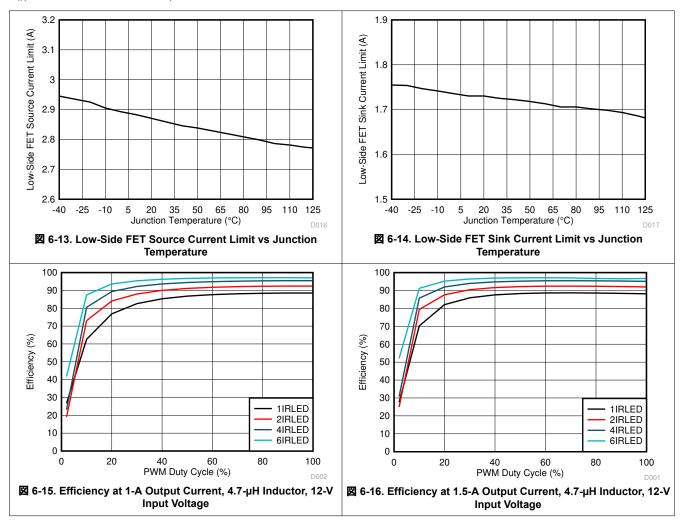


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6.7 Typical Characteristics (continued)

 V_{IN} = 12 V, unless otherwise specified.





7 Detailed Description

7.1 Overview

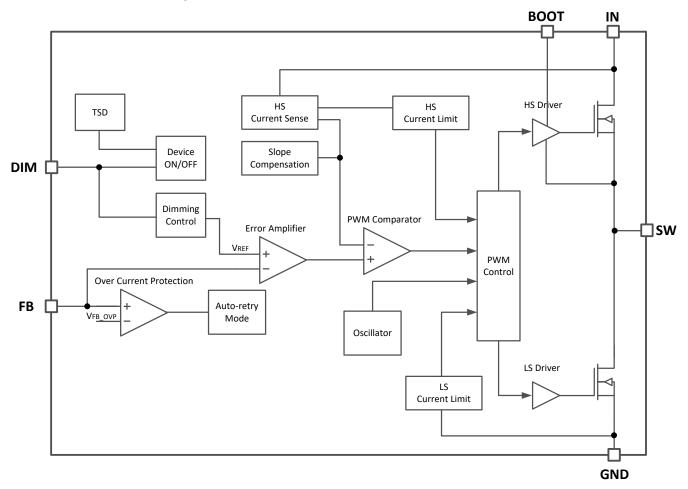
The TPS92200 device is a 1.5-A synchronous buck LED driver with 30-V maximum input voltage. By integrating the high-side and low-side NMOS switches, the TPS92200 device provides high power density with high efficiency in an ultra-small solution size.

The TPS92200 device is fully internally compensated without additional external components, which enables a simple design on a limited board space. The device uses peak current mode control to regulate the LED current with high accuracy. Switching frequency is internally set to 1 MHz, allowing the use of extremely small surfacemount inductors and chip capacitors.

The TPS92200 devices support flexible dimming methods. TPS92200D1 implement both PWM and analog dimming modes. In PWM dimming mode, the LED turns on and off according to PWM duty cycle periodically. The device's analog dimming mode is achieved by changing the internal reference voltage proportional to the voltage level of the analog input in 5% to 100% range. TPS92200D2 implement deeper analog dimming by changing the internal reference voltage proportional to the duty cycle of the PWM signal input in 1% to 100% range.

For safety and protection, the TPS92200 devices implement full protections include LED open, LED+ short-to-GND, LED short, sense resistor open and short, and device thermal protection. Hiccup mode is triggered at current limit or FB pin overvoltage scenario to avoid the device overheats.

7.2 Functional Block Diagram



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7.3 Feature Description

7.3.1 Peak-Current-Mode PWM Control

The TPS92200 device uses peak-current-mode control and full internal compensation to provide high transient response performance over a wide range of operating conditions. The switching frequency is internally set to 1 MHz when the minimum off time t_{MIN_OFF} is not triggered, thus minimizing the external inductor and capacitor size.

During each switching cycle, when the high-side power switch is turned on, the load current is sensed through the external sense resistor, R_{SENSE} . The sensed voltage on the FB pin is compared with the internal voltage reference, V_{REF} , through the error amplifier. The output of the error amplifier, V_{COMP} , is compared with the real-time current, I_{HS_SENSE} , going through the high-side power switch. Slope compensation circuitry is implemented in the device to prevent sub-harmonic oscillations as the duty cycle increases in peak-current-control mode. When the peak value of V_{HS_SENSE} reaches V_{COMP} in the PWM comparator, the high-side power switch is turned off and the low-side NMOS is turned on at the same time. The low-side power switch stays turned on until the end of the PWM cycle. Thus, by regulating the real-time peak current in each switching cycle, the device controls the load current at the target value.

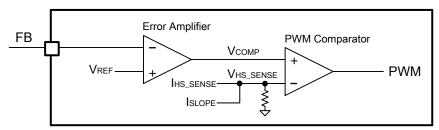


図 7-1. Error Amplifier and PWM Comparator

7.3.2 Setting LED Current

The LED current is set by the external resistor between the LEDs cathode and GND. Because the FB pin voltage reference $V_{FB\ REF}$ is fixed at 99 mV, the sensing resistor can be calculated using \pm 1.

$$R_{SENSE} = \frac{V_{FB_REF}}{I_{LED}}$$
 (1)

7.3.3 Internal Soft Start

The TPS92200 device implements the internal soft-start function. The V_{REF} ramps smoothly during the soft-start period. The internal soft-start period is set as t_{SS} , 0.5 ms typically.

7.3.4 Input Undervoltage Lockout

The device implements internal Undervoltage Lockout (UVLO) circuitry on the IN pin. The device is disabled when the IN pin voltage falls below the internal IN UVLO threshold, 3.5-V typical. The internal IN UVLO threshold has a hysteresis of 0.2-V typical.

7.3.5 Bootstrap Regulator

The TPS92200 integrates a bootstrap regulator inside, and requires an external capacitor between the BOOT and SW pins to provide the gate driver voltage for the high-side power switch. TI recommends a 0.1-µF ceramic capacitor with an X7R or X5R dielectric because of the stable characteristics over temperature and voltage.

7.3.6 Maximum Duty Cycle

For a buck LED driver, the maximum duty cycle is limited by the minimum off time t_{MIN_OFF} and switching frequency. To achieve the maximum brightness when the input voltage is close to output voltage, the TPS92200 device has a mechanism to decrease the switching frequency. This mechanism extends the on-time up to t_{MAX_ON} , 6.6 μ s (typical). With this function, the TPS92200 device maximum duty cycle is able to go up to t_{MAX} , 99% (typical).



7.3.7 Overcurrent Protection

The device is protected from overcurrent conditions by cycle-by-cycle current limiting on both the high-side NMOS and the low-side NMOS.

7.3.7.1 High-Side MOSFET Overcurrent Protection

During each switching on cycle, the high-side sense voltage, V_{HS_SENSE} , is compared with V_{COMP} to generate the PWM duty cycle. To prevent an overcurrent stress, V_{COMP} is internally clamped to set the high-side NMOS current limit as I_{LIM_HS} . When the peak of I_{HS_SENSE} exceeds I_{LIM_HS} , the high-side MOSFET is turned off and the low-side MOSFET is turned on accordingly. An auto-retry mechanism is implemented for this case, if an output overcurrent condition occurs for more than auto-retry on time t_{RETRY_ON} , which is programmed for 512 switching cycles, the device shuts down for an auto-retry off-time t_{RETRY_OFF} , which is 60 ms typically.

7.3.7.2 Low-Side MOSFET Sourcing Overcurrent Protection

During each switching off-cycle, the low-side MOSFET is turned on and the conduction current is monitored by the internal circuitry. At the end of every clock cycle, the low-side MOSFET sourcing current is compared to the internally set low-side sourcing-current limit, $I_{LIM_LS_SOUR}$. If the low-side sourcing-current limit is exceeded, the high-side MOSFET does not turn on and the low-side MOSFET stays on for the next clock cycle. The high-side MOSFET turns on again when the low-side current is below the low-side sourcing current limit at the start of a cycle.

7.3.7.3 Low-Side MOSFET Sinking Overcurrent Protection

During each switching off-cycle, the device also monitors the sinking current of the low-side MOSFET by detecting the voltage across it and setting a sinking overcurrent limit, I_{LIM_LS_SINK}, to protect the low-side power switch from overstress. When the peak of the sinking current reaches I_{LIM_LS_SINK}, both the high-side MOSFET and low-side MOSFET are turned off. The high-side MOSFET turns on again when the low-side current is below the low side sinking current-limit at the start of a new cycle.

Product Folder Links: TPS92200

7.3.8 Fault Protection

The device is protected from several kinds of fault conditions, such as LED open and short, sense resistor open and short, and thermal shutdown.

表 7-1. Protections

TYPE	CRITERION	BEHAVIOR
LED open load	V _{FB} close to 0 mV	The device keeps maximum duty cycle turn-on.
LED+ and LED- short circuit	V _{FB} > V _{FB_OVP}	When $V_{FB} > V_{FB_OVP}$, the device keeps the minimum on-time, and starts the auto-retry timer. During the auto-retry mode, the device is protected by the overcurrent limits.
LED+ short-to-GND	High-side or low-side NMOS current limit triggered	When the high-side or low-side MOSFET current limit is triggered, the device starts the auto-retry timer.
Sense-resistor open load	V _{FB} > V _{FB_OVP}	When V_{FB} > V_{FB_OVP} , the device keeps the minimum on-time, and starts the auto-retry timer.
Sense-resistor short circuit to GND	High-side or low-side MOSFET current limit triggered	When the high-side or low-side MOSFET current limit is triggered, the device starts the auto-retry timer.
Thermal shutdown	T _J > T _{TSD}	Disable the device when $T_J > T_{TSD}$, re-activate the device when T_J falls below the hysteresis level.

7.3.8.1 LED Open-Load Protection

When LED load is open, V_{FB} voltage is low. The internal error amplifier output voltage, V_{COMP} , is driven high and clamped. The high-side MOSFET is forced to turn on with the maximum PWM duty cycle, D_{MAX} .

7.3.8.2 LED+ and LED- Short Circuit Protection

When LED+ and LED- are shorted, V_{FB} is higher than internal reference voltage, V_{REF} , and internal error amplifier output voltage V_{COMP} is driven low and clamped. The high-side MOSFET is forced to turn on with the minimum on-time each cycle, t_{MIN_ON} . In this case, if the output voltage is too low, the inductor current cannot balance in a cycle, causing current runaway. Finally, the inductor current is clamped by low-side MOSFET sourcing current limit $I_{LIM_LS_SOUR}$ which is 3-A typical. If V_{FB} rises higher than V_{FB_OVP} , the device starts the auto-retry timer. After the counter, t_{RETRY_ON} , expires, the device shuts down and starts another counter, t_{RETRY_OFF} . During the shutdown period, both high-side and low-side MOSFETs are turned off. After the hiccup timer expires, TPS92200 restarts again. The device repeats these behaviors until the failure condition is removed. During the auto-retry mode, the device is also protected by the overcurrent limits of both high-side power switch and low-side power switch.

7.3.8.3 LED+ Short Circuit to GND Protection

When LED+ is shorted to GND, V_{FB} is low and V_{COMP} is driven high and clamped. The high-side MOSFET is forced to turn on with maximum PWM duty cycle, after either the high-side or low-side overcurrent limit is triggered, the device starts the auto-retry counter. When the counter t_{RETRY_ON} expires, the device shuts down and starts another counter t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed.

7.3.8.4 Sense-Resistor Open-Load Protection

When the R_{SENSE} load is open, V_{FB} is higher than V_{REF} , and V_{COMP} is driven low and clamped. The high-side NMOS is forced to turn on with the minimum on-time each cycle, t_{MIN_ON} . If V_{FB} rises higher than V_{FB_OVP} , the device starts the auto-retry timer. After the counter t_{RETRY_ON} expires, the device shuts down and starts another counter t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed. To prevent the FB pin from overvoltage damage during the t_{RETRY_ON} period, the FB pin implements a comparator with a 1-V threshold. If $V_{FB} > 1$ V, both high-side and low-side NMOSs are switched off immediately and the t_{RETRY_OFF} counter starts.

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7.3.8.5 Sense Resistor Short Circuit-to-GND Protection

When R_{SENSE} is shorted to GND, V_{FB} is low and V_{COMP} is driven high and clamped. After the current reaches either the high-side overcurrent limit or low-side overcurrent limit, the device starts the auto-retry counter. After the t_{RETRY_ON} counter expires, the device shuts down and starts another counter, t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed.

7.3.8.6 Overvoltage Protection

When the FB pin, for some reason, has a voltage higher than 1-V applied, the device shuts down immediately. Both high-side and low-side MOSFETs are kept off, and the device starts the auto-retry counter, t_{RETRY_OFF} . When the counter t_{RETRY_OFF} expires, the device restarts again. If the failure still exists, TPS92200 repeats above hiccup shutdown and restart process.

7.3.8.7 Thermal Shutdown

The TPS92200 device implements a thermal shutdown mechanism to protect the device from damage due to overheating. When the junction temperature rises to 160°C (typical), the device shuts down immediately. The TPS92200 device releases thermal shutdown when the junction temperature of the device is reduced to 145°C (typical).

Product Folder Links: TPS92200

7.4 Device Functional Modes

表 7-2. Functional Modes

Device Name	DIM Pin DIM Pin Constant Low		Dimming Input Type	Dimming Output Type		
TPS92200D1 TPS92200D2	Device full on	Device turned off	Digital signal • Amplitude: V _H > 1.4 V and V _L < 0.3 V • Frequency: 100 Hz–2 kHz	PWM Dimming		
			Analog voltage • Amplitude: 0.65 V–1.2 V	5%–100% Analog Dimming		
			Digital signal Frequency: 20 kHz–200 kHz	1%–100% Analog Dimming		

7.4.1 Enable and Disable the Device

The DIM pin performs not only the dimming function, but also the enable-and-disable function. When the V_{IN} voltage is above the UVLO threshold, the TPS92200 device can be enabled by driving the DIM pin higher than the threshold voltage V_{DIM_H} for a period longer than t_{DIM_ON1} . To disable the device, the DIM pin must be kept lower than the threshold voltage V_{DIM_L} for a period longer than t_{DIM_OFF} . External pulldown is required to set the device as default-disabled, because the DIM pin is designed as a high-impedance input.

7.4.2 TPS92200D1 PWM Dimming

For the TPS92200D1 version, when applying a digital signal on the DIM pin, the device enters into PWM dimming mode. The amplitude of the digital signal must be higher than 1.4 V for high level and less than 0.3 V for low level, which is out of the analog dimming range (0.65 V–1.2 V). TI recommends the frequency of the digital signal be from 100 Hz to 2 kHz to achieve good dimming accuracy. In PWM dimming mode, the output turns on and off simultaneously with the digital-input high and low pulses, respectively.

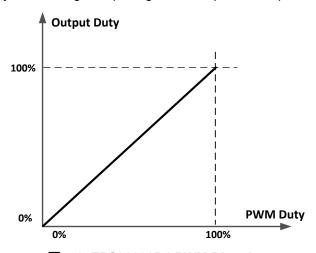


図 7-2. TPS92200D1 PWM Dimming

7.4.3 TPS92200D1 Analog Dimming

For the TPS92200D1 version, when applying an analog voltage on the DIM pin and the amplitude is between 0.65 V and 1.2 V, the device enters into analog dimming mode, and the reference voltage V_{REF} is changed proportionally to the analog input level. When V_{DIM} = 0.65 V, the reference voltage is 5 mV. When V_{DIM} = 1.2 V, the reference voltage is 99 mV.

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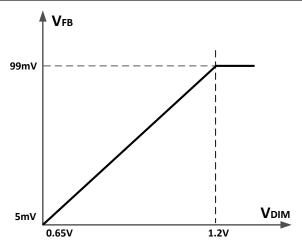


図 7-3. TPS92200D1 Analog Dimming

7.4.4 TPS92200D2 Analog Dimming

The TPS92200D2 version supports accurate analog dimming with a digital signal. When applying a digital signal on the DIM pin, the device enters into analog dimming mode, and the reference voltage V_{REF} is changed proportionally to the duty cycle of digital input. The frequency of the digital signal must be within the range of 20 kHz to 200 kHz.

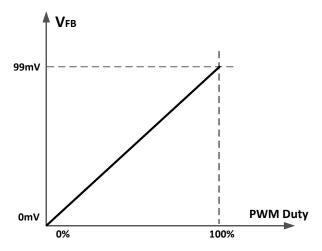


図 7-4. TPS92200D2 Analog Dimming

8 Application and Implementation

Note

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8.1 Application Information

The TPS92200 device is typically used as a buck converter to drive one or more LEDs from a 4-V to 30-V input.

8.2 Typical Application

8.2.1 TPS92200D1 12-V Input, 1.5-A, 2-Piece IR LED Driver With Analog Dimming

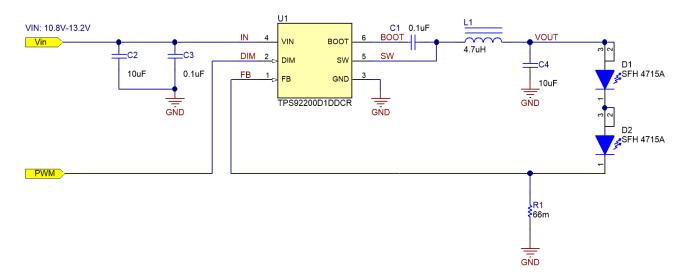


図 8-1. 12-VIN, 1.5-A, 2-piece IR LED, Analog Dimming Reference Design

8.2.1.1 Design Requirements

For this design example, use the parameters in the following table.

PARAMETER VALUE Input voltage range 12 V ±10% LED forward voltage 1.75 V Output voltage 3.6 V (1.75 × 2 + 0.1) Maximum LED current 1.5 A 30% of maximum LED current Inductor current ripple LED current ripple 20 mA or less Input voltage ripple 200 mV or less Analog dimming with TPS92200D1: 0.65-V to 1.2-V analog input on Dimming type DIM pin

表 8-1. Design Parameters

8.2.1.2 Detailed Design Procedure

8.2.1.2.1 Inductor Selection

Use 式 2 to calculate the recommended value of the output inductor L.



$$L = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times K_{IND} \times I_{LED} \times f_{SW}}$$
(2)

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across the LED load and the voltage across the sense resistor.

In general, the value of K_{IND} is suggested between 0.2 and 0.4. For the application that can tolerate higher LED current ripple or use larger output capacitors, one can choose 0.4 for K_{IND} , otherwise, smaller K_{IND} like 0.2 can be chosen to get smaller LED current ripple.

With the chosen inductor value, the user can calculate the actual inductor current ripple using \pm 3.

$$I_{L(ripple)} = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times L \times f_{SW}}$$
(3)

For TPS92200, TI suggests that the inductor current ripple be larger than 300 mA to assure loop stability. If the calculated inductor current ripple is less than 300 mA, TI suggests a smaller inductor.

The inductor RMS current and saturation-current ratings must be greater than those seen in the application. These ratings ensure that the inductor does not overheat or saturate. During power up, transient conditions, or fault conditions, the inductor current can exceed its normal operating current. For this reason, the most conservative approach is to specify an inductor with a saturation current rating equal to or greater than the converter current limit. This action is not always possible due to application size limitations. The peak-inductor-current and RMS current equations are shown in 3.4 and 3.5.

$$I_{L(peak)} = I_{LED} + \frac{I_{L(ripple)}}{2}$$
(4)

$$I_{L(rms)} = \sqrt{I_{LED}^2 + \frac{I_{L(ripple)}^2}{12}}$$
 (5)

In this design, $V_{IN(max)}$ = 13.2 V, V_{OUT} = 3.6 V, I_{LED} = 1.5 A, choose K_{IND} = 0.3, the calculated inductance is 5.8- μ H. A 4.7- μ H inductor is chosen. With this inductor, the ripple, peak, and RMS currents of the inductor are 0.56 A, 1.78 A and 1.51 A respectively. The chosen inductor has ample margin.

8.2.1.2.2 Input Capacitor Selection

The device requires an input capacitor to reduce the surge current drawn from the input supply and the switching noise from the device. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10-µF capacitor with an additional 0.1-µF capacitor from VIN to GND to provide additional high-frequency filtering is enough. The input capacitor voltage rating must be greater than the maximum input voltage.

In this design, a 10-µF, 35-V X7R ceramic capacitor is chosen. This yields around 40-mV input ripple voltage.

8.2.1.2.3 Output Capacitor Selection

The output capacitor reduces the high-frequency ripple current through the LED string. Various guidelines disclose how much high-frequency ripple current is acceptable in the LED string. Excessive ripple current in the LED string increases the RMS current in the LED string, and therefore the LED temperature also increases.

Calculate the total dynamic resistance of the LED string (R_{LED}) using the LED manufacturer's data sheet.

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- 2. Calculate the required impedance of the output capacitor (ZOUT) given the acceptable peak-to-peak ripple current through the LED string, I_{LED(ripple)} × I_{L(ripple)}, is the peak-to-peak inductor ripple current as calculated previously in inductor selection.
- 3. Calculate the minimum effective output capacitance required.
- 4. Increase the output capacitance appropriately due to the derating effect of applied dc voltage.

See 式 6, 式 7, and 式 8.

$$R_{LED} = \frac{\Delta V_F}{\Delta I_F} \times \# \ of \ LEDs \tag{6}$$

$$Z_{COUT} = \frac{(R_{LED} + R_{SENSE}) \times I_{LED(ripple)}}{I_{L(ripple)} - I_{LED(ripple)}}$$
(7)

$$C_{OUT} = \frac{1}{2\pi \times f_{SW} \times Z_{COUT}} \tag{8}$$

After the output capacitor is chosen, \pm 9 can be used to estimate the peak-to-peak ripple current through the LED string.

$$I_{LED(ripple)} = \frac{Z_{COUT} \times I_{L(ripple)}}{Z_{COUT} + R_{LED} + R_{SENSE}}$$
(9)

OSRAM SFH4715A IR LED is used here. The dynamic resistance of this LED is 0.29 ohm at 1.5-A forward current. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. In this design, a 10-µF, 35-V X7R ceramic capacitor is chosen, the part number is GRM32ER7YA106KA12L. The calculated ripple current of the LED is about 23.8 mA.

8.2.1.2.3.1 Sense Resistor Selection

The maximum LED current is 1.5 A at 100% PWM duty and the corresponding V_{REF} is 99 mV. By using \pm 1, calculate the needed sense resistance at 66 mΩ. Pay close attention to the power consumption of the sense resistor in this design at 148.5 mW, and make sure the chosen resistor has enough margin in its power rating.

8.2.1.2.3.1.1 Other External Components Selection

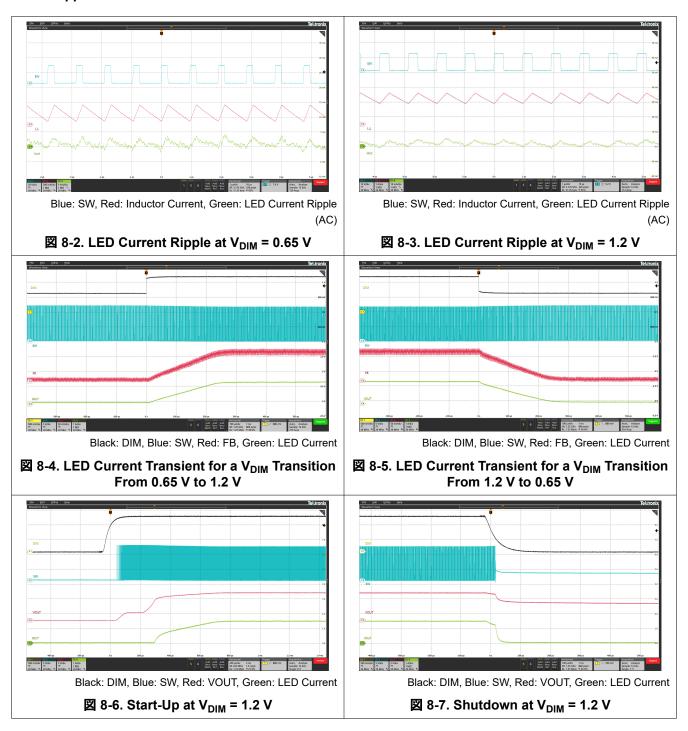
In this design, a 0.1-µF, 50-V X7R ceramic capacitor is chosen for C_{BOOT}.

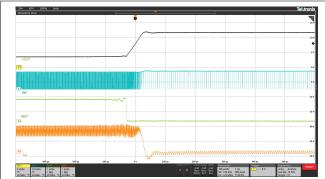
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8.2.1.3 Application Curves



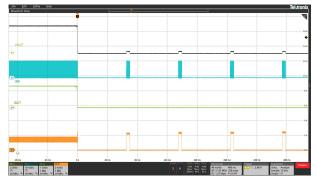


Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor



Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor

図 8-8. LED Open-Load Protection



Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

図 8-9. LED+ Short-to-GND Protection

Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

図 8-10. LED+ and LED- Short Circuit-



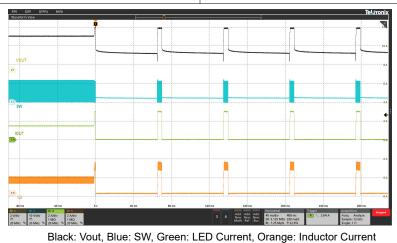


図 8-12. Sense-Resistor Short-to-GND Protection



8.2.2 TPS92200D1 24-V Input, 1-A, 6-Piece WLED Driver With PWM Dimming

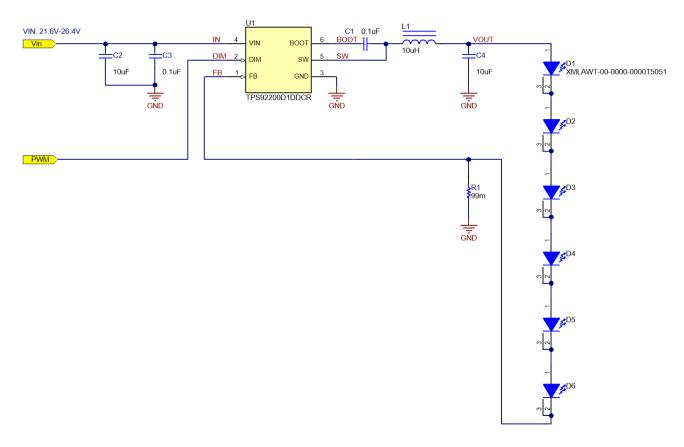


図 8-13. 24-VIN, 1-A, 6-piece WLED, PWM Dimming Reference Design

8.2.2.1 Design Requirements

For this design example, use the parameters in the following table.

PARAMETER VALUE 24 V ±10% Input voltage range 3 V LED forward voltage Output voltage 18.1 V (3 × 6 + 0.1) Maximum LED current 1 A 60% of maximum LED current Inductor current ripple LED current ripple 20 mA or less Input voltage ripple 200 mV or less PWM dimming with TPS92200D1: 500 Hz, 1% to 100% duty cycle Dimming type input on the DIM pin

表 8-2. Design Parameters

8.2.2.2 Detailed Design Procedure

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8.2.2.2.1 Inductor Selection

For this application, input voltage is 24-V rail with 10% variation, output is 6 white LEDs in series and the inductor current ripple requirement is less than 60% of maximum LED current. To choose a proper peak-to-peak inductor current ripple, the low-side FET sink current limit must not be violated when the converter works in no-load condition. This action requires the half of peak-to-peak inductor current ripple to be lower than that limit. Another consideration is the increased core loss and copper loss in the inductor with this larger peak-to-peak

Product Folder Links: TPS92200

current ripple which is also acceptable. After this peak-to-peak inductor current ripple is chosen, use $\stackrel{>}{
ightharpoonup}$ 10 to calculate the recommended value of the output inductor L.

$$L = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times K_{IND} \times I_{LED} \times f_{SW}}$$
(10)

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor-current ripple using 式 11.

$$I_{L(ripple)} = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times L \times f_{SW}}$$
(11)

In this design, $V_{IN(max)}$ = 26.4 V, V_{OUT} = 18.1 V, I_{LED} = 1 A, choose K_{IND} = 0.6, the calculated inductance is 9.49 μ H. A 10- μ H inductor is chosen. With this inductor, the ripple, peak, and rms currents of the inductor are 0.57 A, 1.29 A, and 1.01 A, respectively.

8.2.2.2.2 Input Capacitor Selection

In this design, a 10-µF, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L, from muRata is chosen. This ceramic capacitor yields around 30-mV input-ripple voltage.

8.2.2.3 Output Capacitor Selection

The dynamic resistance of this Cree white LED is 0.67 ohm at 1-A forward current. In this design, choose a 10- μ F, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L. The calculated ripple current of LED is about 11.5mA.

8.2.2.2.3.1 Sense Resistor Selection

The maximum LED current is 1 A, and the corresponding V_{REF} is 99 mV. Using \pm 1, calculate the needed sense resistance at 99 m Ω . Pay close attention to the power consumption of the sense resistor in this design at 99 mW, and make sure the chosen resistor has enough margin in its power rating.

8.2.2.3.1.1 Other External Components Selection

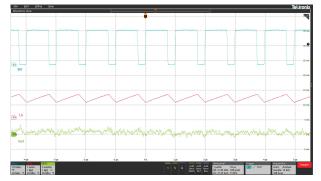
See the Other External Components Selection.

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8.2.2.3 Application Curves



Blue: SW, Red: Inductor Current, Green: LED Current Ripple

図 8-14. LED Current Ripple at 100% Duty Cycle

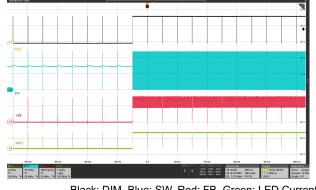
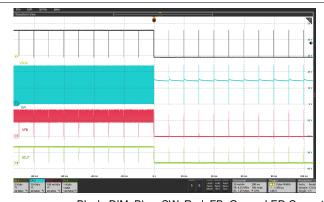


図 8-15. LED Current Transient From 1% to 100%

Black: DIM, Blue: SW, Red: FB, Green: LED Current

and 500 Hz



Black: DIM, Blue: SW, Red: FB, Green: LED Current

図 8-16. LED Current Transient From 100% to 1%

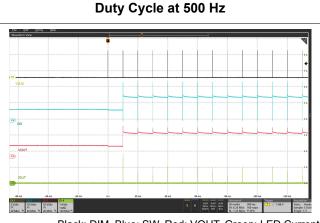


図 8-17. Start-Up at 1% Duty Cycle and 500 Hz

Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

Duty Cycle at 500 Hz

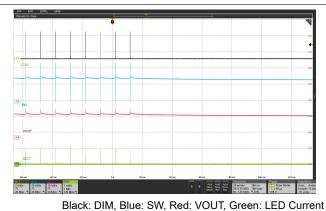
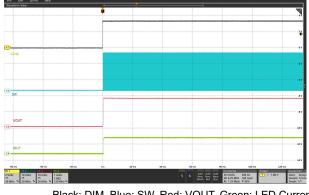


図 8-18. Shutdown at 1% Duty Cycle and 500 Hz



Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

図 8-19. Start-Up at 100% Duty Cycle and 500 Hz

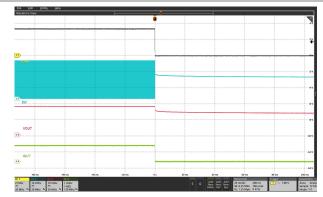
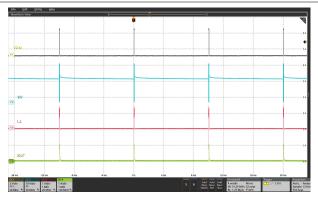


図 8-20. Shutdown at 100% Duty Cycle and 500 Hz

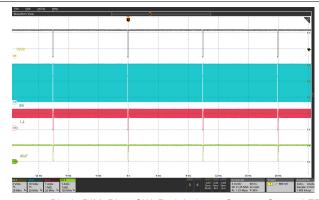


Black: DIM, Blue: SW, Red: Inductor Current, Green: LED

図 8-21. LED PWM Dimming at 1% Duty Cycle and 200 Hz



Black: DIM, Blue: SW, Red: Inductor Current, Green: LED



Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

図 8-22. LED PWM Dimming at 50% Duty Cycle and 200 Hz

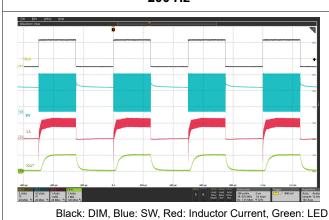
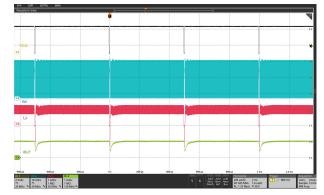


図 8-24. LED PWM Dimming at 50% Duty Cycle and 2 kHz

図 8-23. LED PWM Dimming at 99% Duty Cycle and 200 Hz



Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

図 8-25. LED PWM Dimming at 99% Duty Cycle and 2 kHz

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Current



8.2.3 5-V Input, 1-A, 1-Piece IR LED Driver With TPS92200D2

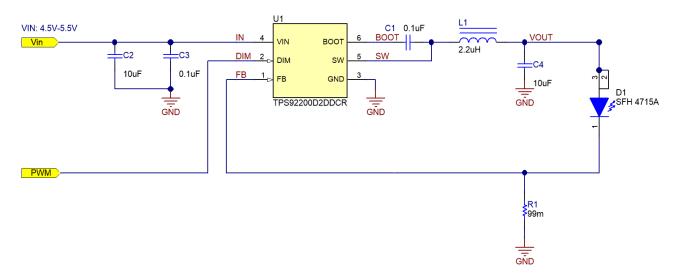


図 8-26. 5-VIN, 1-A, 1-piece IR LED, Analog Dimming Reference Design

8.2.3.1 Design Requirements

For this design example, use the parameters in the below table.

PARAMETER VALUE Input voltage range 5 V ±10% 1.75 V LED forward voltage Output voltage 1.85 V (1.75 + 0.1) Maximum LED current Inductor current ripple 60% of maximum LED current LED current ripple 20 mA or less Input voltage ripple 200 mV or less Analog dimming with TPS92200D2: 50 kHz, 1% to 100 % duty cycle Dimming type input on the DIM pin

表 8-3. Design Parameters

8.2.3.2 Detailed Design Procedure

8.2.3.2.1 Inductor Selection

For this application, input voltage is 5-V rail with 10% variation, output is a single IR LED, and the inductor current ripple requirement is less than 60% of maximum LED current.

Use \pm 12 to calculate the minimum value of the output inductor (L_{MIN}).

$$L = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times K_{IND} \times I_{LED} \times f_{SW}}$$
(12)

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor current ripple using 式 13.



$$I_{L(ripple)} = \frac{V_{OUT} \times (V_{VIN(\max)} - V_{OUT})}{V_{VIN(\max)} \times L \times f_{SW}}$$
(13)

In this design, $V_{IN(max)}$ = 5.5 V, V_{OUT} = 1.85 V, I_{LED} = 1 A, choose K_{IND} = 0.6. The calculated inductance is 2.046 μ H. A 2.2- μ H inductor is chosen. With this inductor, the ripple, peak, and RMS currents of the inductor are 0.56 A, 1.28 A, and 1.01 A, respectively.

8.2.3.2.2 Input Capacitor Selection

In this design, a 10-µF, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L, from muRata is chosen. This ceramic capacitor yields around 30-mV input ripple voltage.

8.2.3.2.3 Output Capacitor Selection

The dynamic resistance of this LED is 0.29 ohm at 1-A forward current. In this design, choose a 10- μ F, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12. The calculated ripple current of LED is about 21.9 mA.

8.2.3.2.3.1 Sense Resistor Selection

The maximum LED current is 1 A, and the corresponding V_{REF} is 99 mV. Using $\stackrel{1}{\not\sim}$ 1, calculate the needed sense resistance at 99 m Ω . Pay close attention to the power consumption of the sense resistor in this design at 99 mW, and make sure the chosen resistor has enough margin in its power rating.

8.2.3.2.3.1.1 Other External Components Selection

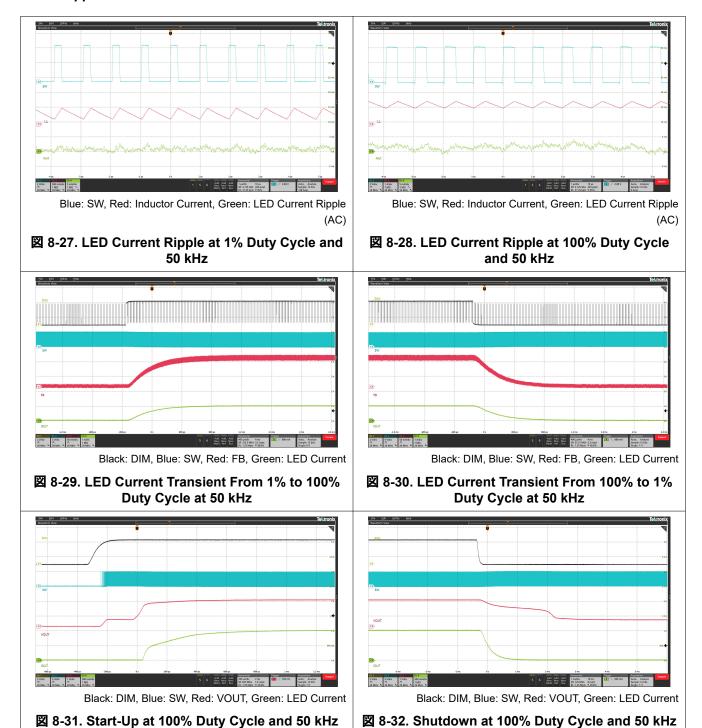
See the Other External Components Selection section.

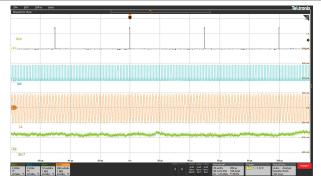
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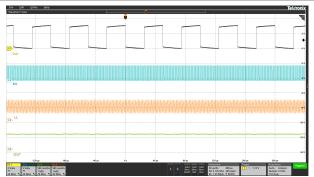


8.2.3.3 Application Curves





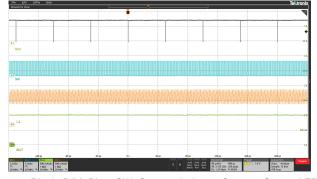
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED



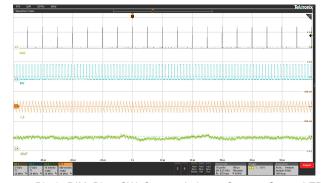
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED

図 8-33. LED Analog Dimming at 1% Duty Cycle and 20 kHz

図 8-34. LED Analog Dimming at 50% Duty Cycle d 20 kHz



Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED



Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED

図 8-35. LED Analog Dimming at 99% Duty Cycle and 20 kHz



図 8-36. LED Analog Dimming at 1% Duty Cycle and 200 kHz



Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED

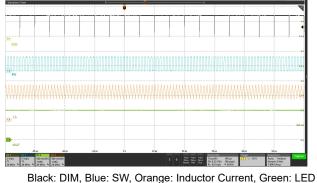


図 8-37. LED Analog Dimming at 50% Duty Cycle and 200 kHz

図 8-38. LED Analog Dimming at 99% Duty Cycle and 200 kHz

9 Power Supply Recommendations

The devices are designed to operate from an input voltage supply range between 4 V and 30 V. This input supply must be well regulated. The device requires an input capacitor to reduce the surge current drawn from the input supply and the switching noise from the device. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10- μ F capacitor is enough.

10 Layout

The TPS92200 device requires a proper layout for optimal performance. The following section gives some guidelines to ensure a proper layout.

10.1 Layout Guidelines

An example of a proper layout for the TPS92200 device is shown in 2 10-1.

- · Creating a large GND plane for good electrical and thermal performance is important.
- The IN and GND traces must be as wide as possible to reduce trace impedance. Wide traces have the additional advantage of providing excellent heat dissipation.
- Thermal vias can be used to connect the top-side GND plane to additional printed-circuit board (PCB) layers for heat dissipation and grounding.
- The input capacitors must be located as close as possible to the IN pin and the GND pin.
- · The SW trace must be kept as short as possible to reduce radiated noise and EMI.
- · Do not allow switching current to flow under the device.
- The FB trace must be kept as short as possible and placed away from the high-voltage switching trace and the ground shield.
- In higher-current applications, routing the load current of the current-sense resistor to the junction of the input capacitor and GND node can be necessary.

10.2 Layout Example

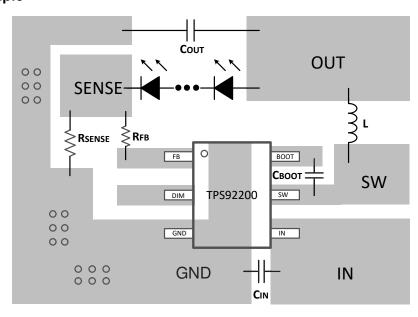


図 10-1. DDC Package Layout Example



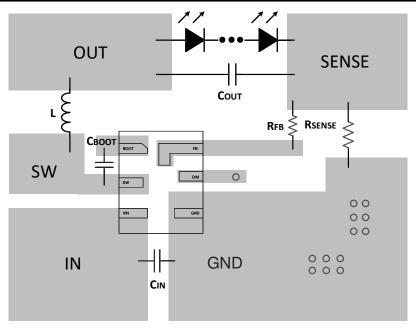


図 10-2. RXL Package Layout Example



11 Device and Documentation Support

11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.2 サポート・リソース

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11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most-current data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.

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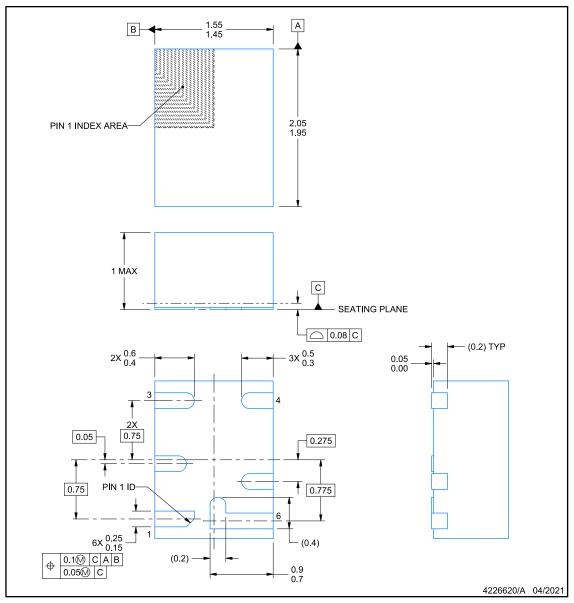
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RXL0006A

PACKAGE OUTLINE

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.



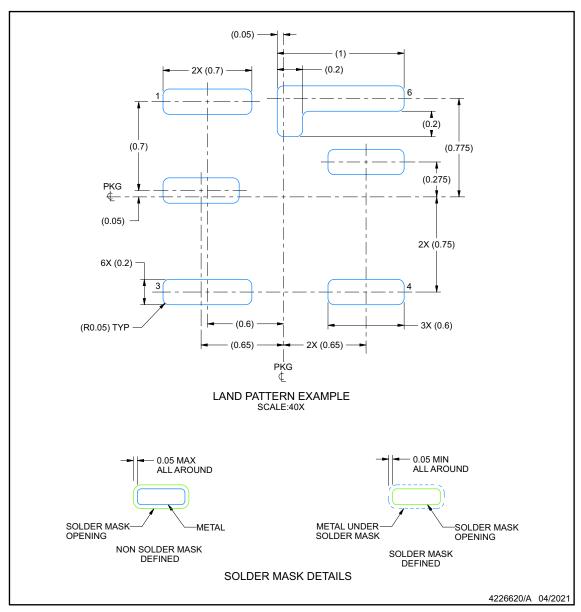


EXAMPLE BOARD LAYOUT

RXL0006A

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

 $3. \ For more information, see \ Texas \ Instruments \ literature \ number \ SLUA271 \ (www.ti.com/lit/slua271).$



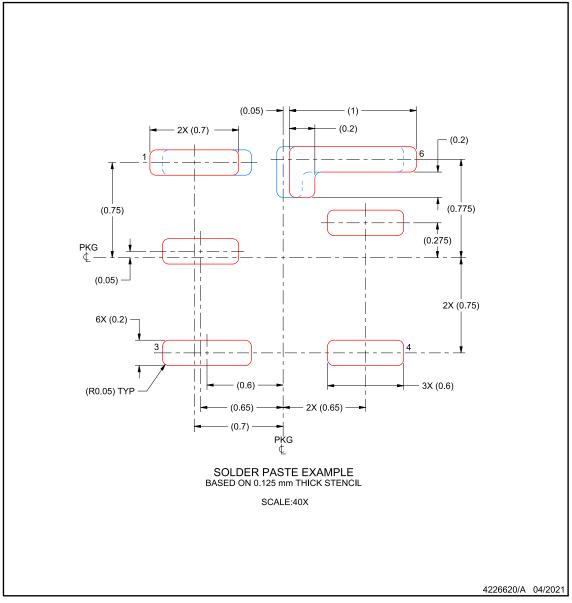


EXAMPLE STENCIL DESIGN

RXL0006A

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



9-Nov-2025

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
TPS92200D1DDCR	Active	Production	SOT-23- THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1SZK
TPS92200D1DDCR.A	Active	Production	SOT-23- THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1SZK
TPS92200D1RXLR	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JQ
TPS92200D1RXLR.A	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JQ
TPS92200D2DDCR	Active	Production	SOT-23- THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1T1K
TPS92200D2DDCR.A	Active	Production	SOT-23- THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1T1K
TPS92200D2RXLR	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JP
TPS92200D2RXLR.A	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JP

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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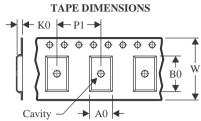
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

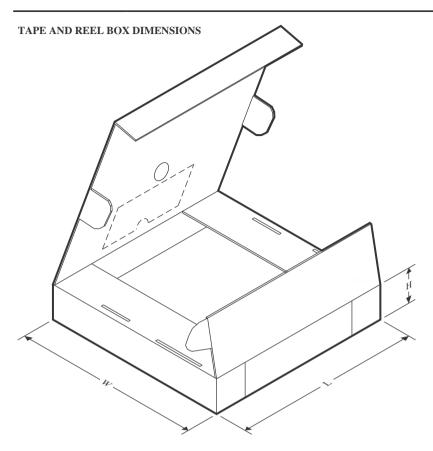


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS92200D1DDCR	SOT-23- THIN	DDC	6	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS92200D1RXLR	VQFN- HR	RXL	6	3000	180.0	8.4	1.75	2.25	1.0	4.0	8.0	Q1
TPS92200D2DDCR	SOT-23- THIN	DDC	6	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS92200D2RXLR	VQFN- HR	RXL	6	3000	180.0	8.4	1.75	2.25	1.0	4.0	8.0	Q1



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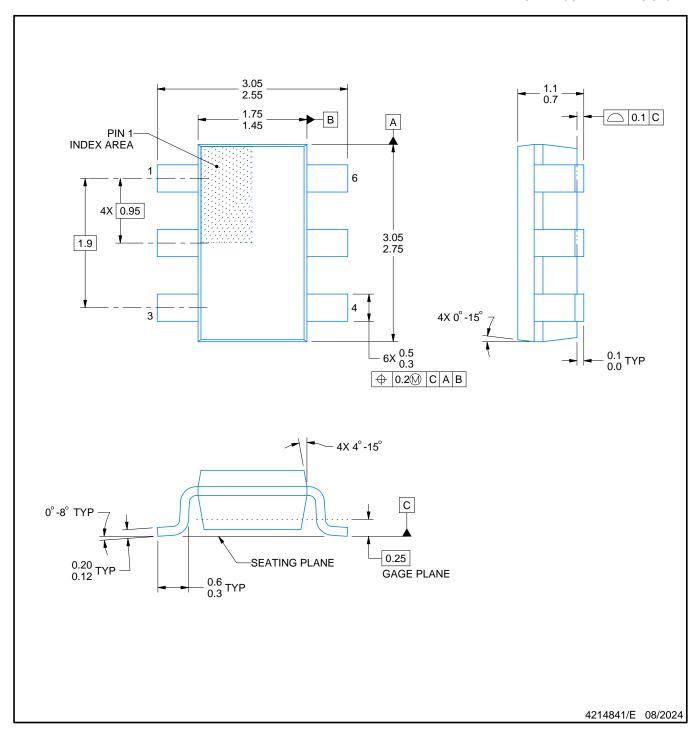


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins SPQ		Length (mm)	Width (mm)	Height (mm)
TPS92200D1DDCR	SOT-23-THIN	DDC	6	3000	210.0	185.0	35.0
TPS92200D1RXLR	VQFN-HR	RXL	6	3000	210.0	185.0	35.0
TPS92200D2DDCR	SOT-23-THIN	DDC	6	3000	210.0	185.0	35.0
TPS92200D2RXLR	VQFN-HR	RXL	6	3000	210.0	185.0	35.0



SMALL OUTLINE TRANSISTOR

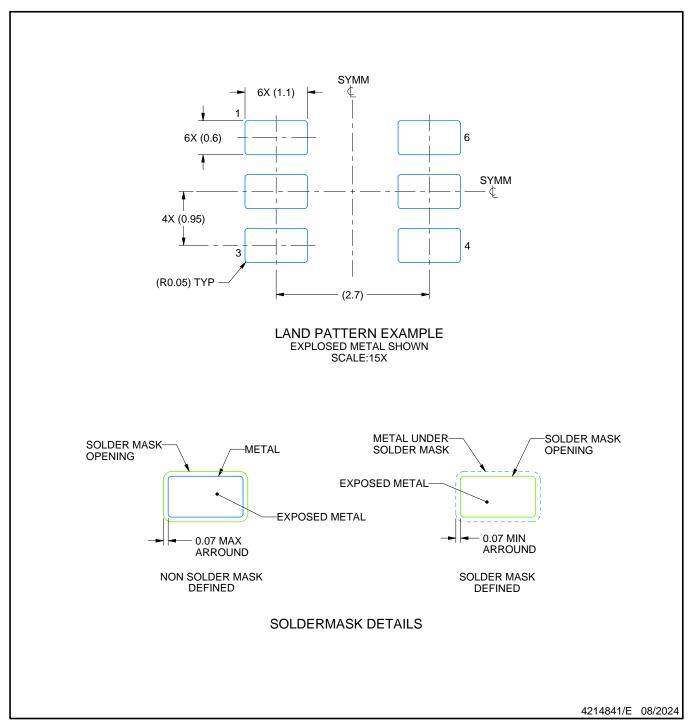


NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-193.



SMALL OUTLINE TRANSISTOR

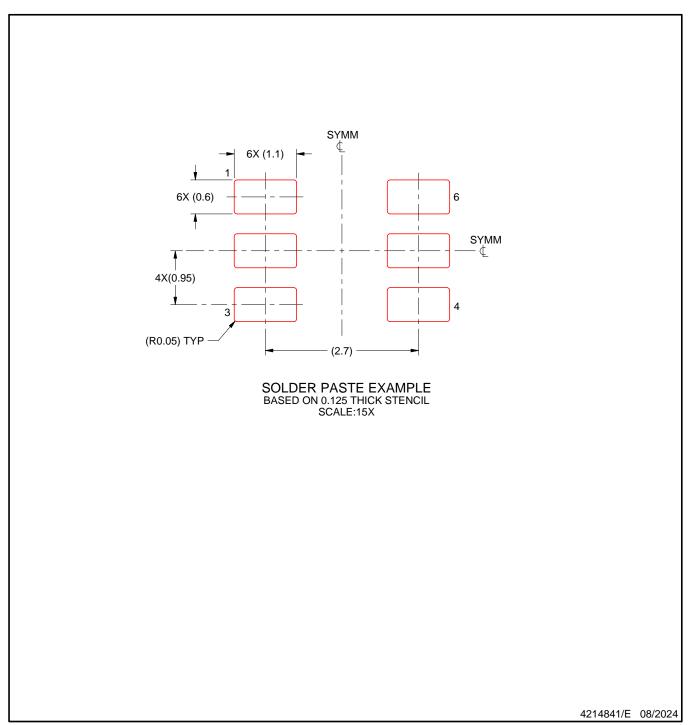


NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

 7. Board assembly site may have different recommendations for stencil design.



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